

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2127	substrate and (emboss\$3 imprint\$3 mold\$3 press\$3) and metal with (wiring trace) with (groove opening via trench cavity recess) and (chip die) and @ad<"20031201"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 11:44
L2	628	substrate and (emboss\$3 imprint\$3 mold\$3 press\$3) with (polymer resin) and metal with (wiring trace) with (groove opening via trench cavity recess) and (chip die) and @ad<"20031201"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 11:44
L3	8	substrate and (emboss\$3 imprint\$3 mold\$3 press\$3) with (polymer resin) with (release near agent) and metal with (wiring trace) with (groove opening via trench cavity recess) and (chip die) and @ad<"20031201"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 11:48
L4	14	substrate and (emboss\$3 imprint\$3 mold\$3 press\$3) and (polymer resin) with (release near agent) and metal with (wiring trace) with (groove opening via trench cavity recess) and (chip die) and @ad<"20031201"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 11:48

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Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1341	substrate and (emboss\$3 imprint\$3 press\$3) with (polymer resin) and (groove opening recesss trench via cavity) with (fill\$3 deposit\$3) with (metal wiring trace) and @ad<"20031201"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 12:18
L2	881	substrate and (emboss\$3 imprint\$3 press\$3) with (polymer resin) and (groove opening recesss trench via cavity) with (fill\$3 deposit\$3) with (metal wiring trace) and (chip die) and @ad<"20031201"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 12:18
L3	62	2 and (release near agent)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 14:18
L5	299110	257/632,642,643,459.ccls. "257"/("E23.007" "E23.119" "E23.024")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 14:18
L6	2557	5 and polymer and (release near agent)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 14:18
L7	0	5 and methyl near ethyl near ketone and diglycidyl near bisphenol and tetrabromo near bisphenol and ortho near cresol near novolak and polybutadiene near rubber and brominated near phenolic and triazine near isocyanuric and silica and carnauba near wax	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 14:24

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L8	78	((paul near a near koning) (james near c near matayabas)).in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 14:24
L9	1	8 and methyl near ethyl near ketone and diglycidyl near bisphenol and tetrabromo near bisphenol and ortho near cresol near novolak and polybutadiene near rubber and brominated near phenolic and triazine near isocyanuric and silica and carnauba near wax	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/06/22 14:26
L10	3	("6,030,556") or ("6,210,514") or ("6,454,970")).PN. or ((2005/0116387) or (2006/0051453)).CCLS.	US-PGPUB; USPAT	OR	OFF	2007/06/22 14:27
L11	3	("6,030,556") or ("6,210,514") or ("6,454,970")).PN. or ((2005/011,6387) or (2006/0051,453)).CCLS.	US-PGPUB; USPAT	OR	OFF	2007/06/22 14:27
L12	5	("20050116387") or ("20060051453") or ("6,030,556") or ("6,210,514") or ("6,454,970")).PN.	US-PGPUB; USPAT	OR	OFF	2007/06/22 14:27